## Onsemi

# **MOSFET** – N-Channel, SUPERFET<sup>®</sup> II, FRFET<sup>®</sup>

### **650 V, 54 A, 77 m**Ω

## **FCH077N65F**

#### Description

SUPERFET II MOSFET is onsemi's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SUPERFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. SUPERFET II FRFET MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.

#### Features

- 700 V @  $T_{J} = 150^{\circ}C$
- Typ.  $R_{DS(on)} = 68 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Qg = 126 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 693 pF)
- 100% Avalanche Tested
- This Device is Pb-Free, Halide Free and is RoHS Compliant

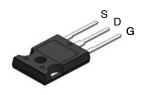
#### Applications

- LCD, LED, PDP TV
- Solar Inverter
- Telecom, Server Power Supplies
- AC–DC Power Supply

V <sub>DS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
650 V	77 m $\Omega$ @ 10 V	54 A

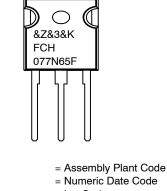
# D GC

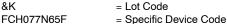




TO-247-3LD CASE 340CH

#### **MARKING DIAGRAM**





&Z

&3

&K

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter		Value	Unit	
V <sub>DSS</sub>	Drain to Source Voltage		650	V	
V <sub>GSS</sub>	Gate to Source Voltage	-DC	±20	V	
		–AC (f > 1 Hz)	±30		
ID	Drain Current	–Continuous (T <sub>C</sub> = 25°C)	54	А	
		–Continuous (T <sub>C</sub> = 100°C)	32		
I <sub>DM</sub>	Drain Current	-Pulsed (Note 1)	162	A	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		1128	mJ	
I <sub>AS</sub>	Avalanche Current		11	A	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		4.81	mJ	
dv/dt	MOSFET dv/dt		100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)		50		
PD	Power Dissipation	(T <sub>C</sub> = 25°C)	481	W	
		-Derate Above 25°C	3.85	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		–55 to + 150	°C	
ΤL	Maximum Lead Temperature for Soldering, 1/8 from Case for 5 Seconds		300	°C	

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality shows be assumed, damage may occur and reliability may be affected. 1. Repetitive Rating: pulse width limited by maximum junction temperature. 2.  $I_{AS} = 11 \text{ A}$ ,  $R_G = 25 \Omega$ , Starting  $T_J = 25^{\circ}C$ 3.  $I_{SD} \le 27 \text{ A}$ , di/dt  $\le 200 \text{ A/}\mu$ s,  $V_{DD} \le 380 \text{ V}$ , Starting  $T_J = 25^{\circ}C$ .

#### **THERMAL CHARACTERISTICS**

Symbol	Parameter	Value	Unit
$R_{\thetaJC}$	Thermal Resistance, Junction to Case, Max.	0.26	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

#### PACKAGE MARKING AND ORDERING INFORMATION

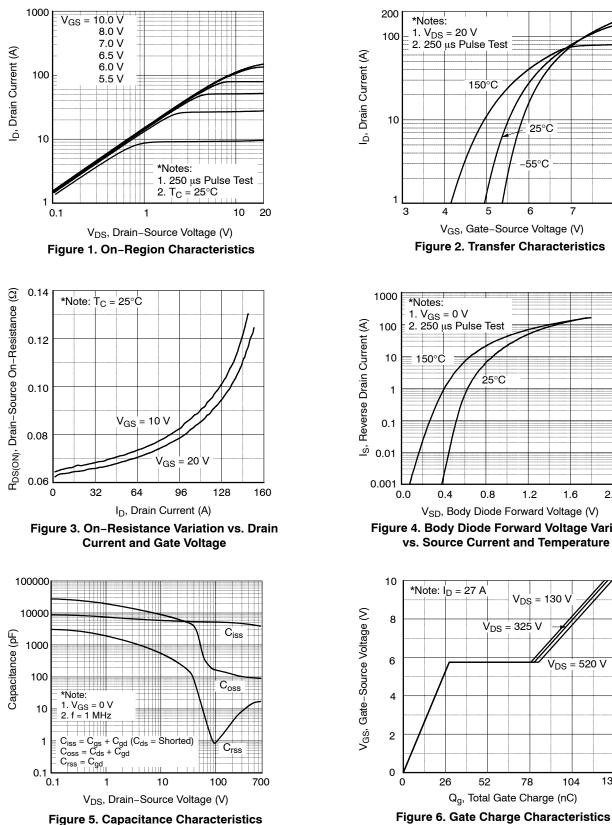
Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FCH077N65F-F155	FCH077N65F	TO-247-3LD	Tube	N/A	N/A	30 Units

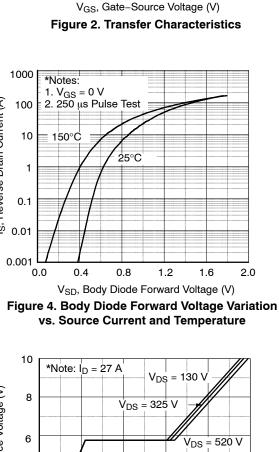
#### **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
OFF CHARA	ACTERISTICS					
BV <sub>DSS</sub> Dr	Drain to Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 10 mA, $T_J$ = 25°C	650	-	-	V
		$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 10 \text{ mA}, \text{ T}_{J} = 150^{\circ}\text{C}$	700	-	-	
$\Delta BV_{DSS}/\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D$ = 10 mA, Referenced to 25°C	-	0.72	-	V/∘C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	10	μA
		$V_{DS}$ = 520 V, $V_{GS}$ = 0 V, $T_{C}$ = 125°C	-	144	-	
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±100	nA
ON CHARAG	CTERISTICS	·				-
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 5.4 \text{ mA}$	3	-	5	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 27 A	-	68	77	mΩ
<b>9</b> FS	Forward Transconductance	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 27 A	-	42	-	S
OYNAMIC C	HARACTERISTICS	•	•			
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V},$	-	5345	7109	pF
C <sub>oss</sub>	Output Capacitance	f = 1 MHz	-	165	220	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	0.8	-	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 380 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	97	_	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS} = 0 \text{ V to } 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	693	-	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V	$V_{DD} = 380 \text{ V}, \text{ I}_{D} = 27 \text{ A},$	-	126	164	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	V <sub>GS</sub> = 10 V (Note 4)	-	28	_	nC
Q <sub>gd</sub>	Gate to Drain "Miller"Charge		-	53	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	0.7	-	Ω
SWITCHING	CHARACTERISTICS	•	•			
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 380 \text{ V}, \text{ I}_{D} = 27 \text{ A},$	-	40	90	ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>GS</sub> = 10 V, R <sub>G</sub> = 4.7 Ω (Note 4)	-	35	80	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	113	236	ns
t <sub>f</sub>	Turn-Off Fall Time		-	5	20	ns
RAIN-SOU	RCE DIODE CHARACTERISTICS		•		•	
IS	Maximum Continuous Drain to Source Diode Forward Current		-	-	54	А
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	162	Α
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 27 A	-	-	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 27 A,	-	163	_	ns
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> /dt = 100 A/µs	_	0.9	_	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature.

#### **TYPICAL PERFORMANCE CHARACTERISTICS**





25°C

.5°℃

6

7

8

130

104

78

#### TYPICAL PREFORMANCE CHARACTERISTICS (continued)

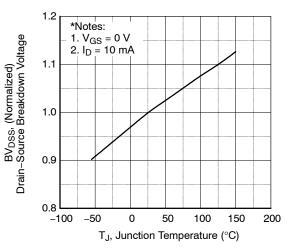


Figure 7. Breakdown Voltage Variation vs. Temperature

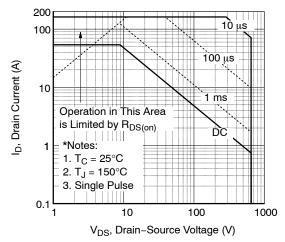


Figure 9. Maximum Safe Operating Area

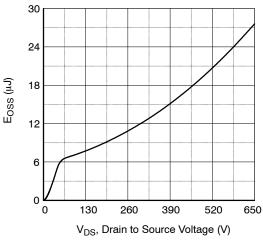


Figure 11.  $E_{\mbox{OSS}}$  vs. Drain to Source Voltage

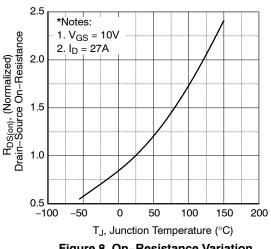


Figure 8. On–Resistance Variation vs. Temperature

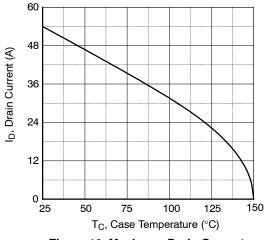
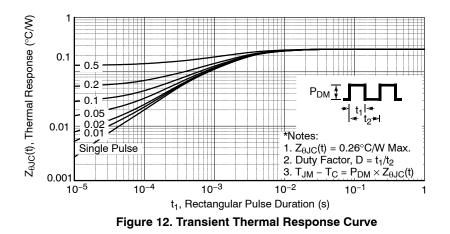
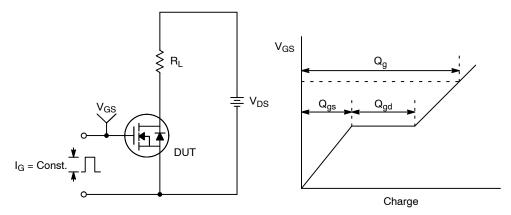


Figure 10. Maximum Drain Current vs. Case Temperature









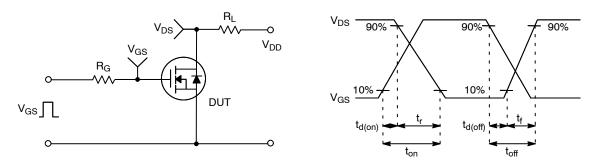


Figure 14. Resistive Switching Test Circuit & Waveforms

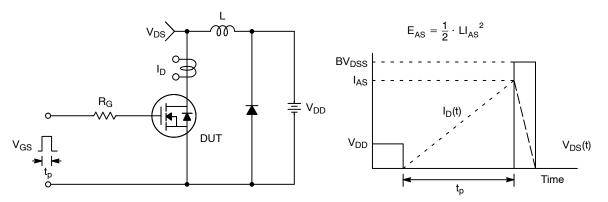


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

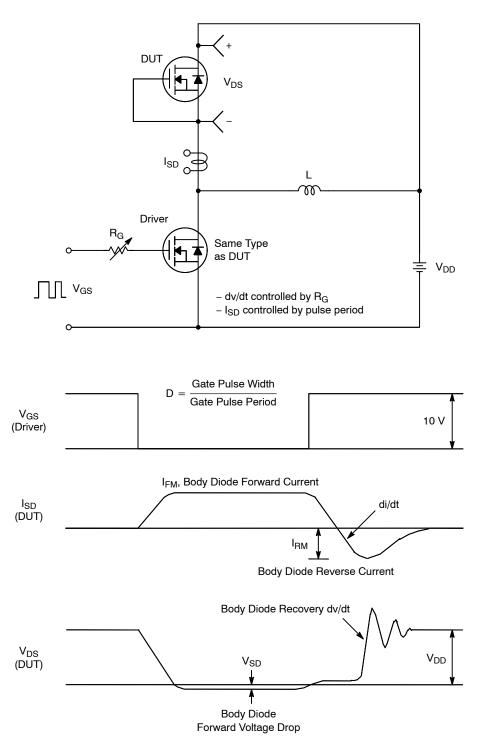


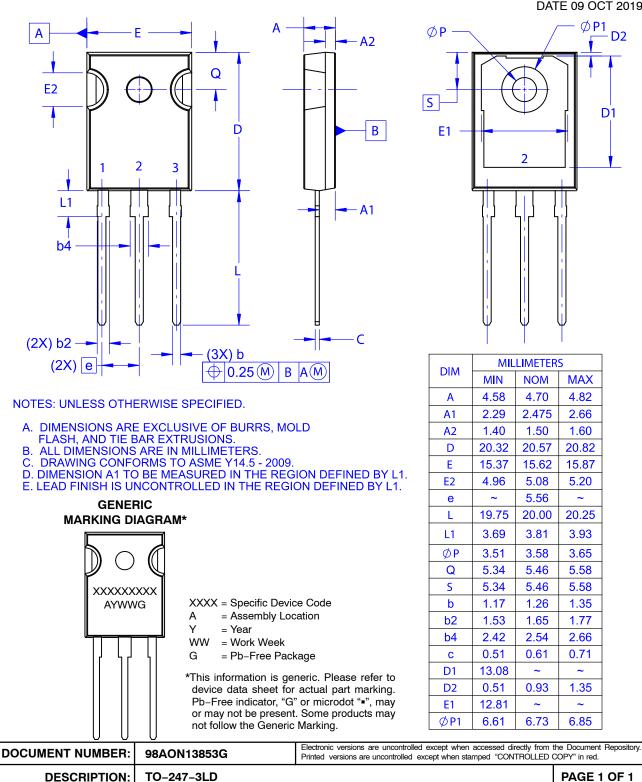
Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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